PATENT ASSIGNMENT

Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE: NEW ASSIGNMENT NATURE OF CONVEYANCE: **ASSIGNMENT**

CONVEYING PARTY DATA

Name	Execution Date
SHEN BO LIN	08/09/2010
CHAO HSIUNG CHANG	08/09/2010
WEN LIANG TSENG	08/09/2010

RECEIVING PARTY DATA

Name:	ADVANCED OPTOELECTRONIC TECHNOLOGY INC.	
Street Address:	NO. 13, GONGYE 5TH RD., HSINCHU INDUSTRIAL PARK, HUKOU TOWNSHIP	
City:	HSINCHU COUNTY	
State/Country:	TAIWAN	
Postal Code:	303	

PROPERTY NUMBERS Total: 1

Property Type	Number	
Application Number:	12902332	

CORRESPONDENCE DATA

Fax Number: (949)743-8963

Correspondence will be sent via US Mail when the fax attempt is unsuccessful.

9492604797 Phone: Email: ahong@wpat.com

WPAT, PC INTELLECTUAL PROPERTY ATTORNEYS Correspondent Name:

Address Line 1: 2030 Main Street, #1300 IRVINE, CALIFORNIA 92614 Address Line 4:

18506-446 ATTORNEY DOCKET NUMBER:

NAME OF SUBMITTER: Anthony King

Total Attachments: 2

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REEL: 025123 FRAME: 0390

501317210

2009-24-3 US ONLY

ASSIGNMENT

WHEREAS, I(we), <u>LIN, SHEN BO</u>; <u>CHANG, CHAO HSIUNG and TSENG, WEN LIANG</u>, whose post office address(es) appear(s) below, hereinafter referred to as ASSIGNOR, have invented certain new and useful invention entitled

LIGHT EMITTING DIODE PACKAGE AND METHOD OF FABRICATING THE SAME

is checked: Serial No.: Patent Application No.: U.S. Patent No.:	filed:	
Patent Application No.:	filed:	
	filed:	
U.S. Patent No.:		designating the United States of America
aluable consideration, receipt said ASSIGNEE, the entire rig cluding any and all Letters Pat or terms for which the same in assignments, sale, agreement cute any documents that legal or patent application(s) in the ASSIGNEE in and to said INVINEE'S expense, to identify and are within ASSIGNOR's possessequired of ASSIGNOR in respectithin the terms of this instrument and other legal representatives and requests the Commissione NEE of the entire right, title are gal representatives and success would have been held by ASSIGNEE firm of WPAT, PC. (6)	of which is here the title and intere of which is here the title, and intere the title, and intere the title, and intere the title, and interes and be granted, interes or encumbrance by may be require United States for ENTION, all without communicate to the title to the prosecut the prosecu	L PARK, HUKOU TOWNSHIP, HSINCHU st in and to the same in the United States and its aby acknowledged, I (we), ASSIGNOR, by these erest in and to said INVENTION and application y division, continuation, continuation-in-part and cluding all priority rights under any International than been or will be made or entered into which as aid INVENTION, including additional documents at further consideration. ASSIGNOR also agrees, ASSIGNEE at ASSIGNEE's request documents and to provide further assurances and testimony on tion, maintenance, litigation and defense of any obligations under this instrument shall extend to the same, for ASSIGNEE's sole use and behoof and of the term for which such Letters Patent may signment and sale not been made.
	aluable consideration, receipt said ASSIGNEE, the entire rigical dual to terms for which the same in assignments, sale, agreement assignments, sale, agreement application(s) in the ASSIGNEE in and to said INVINEE'S expense, to identify and are within ASSIGNOR's possessequired of ASSIGNOR in respectition the terms of this instrume and other legal representatives and requests the Commissione NEE of the entire right, title are gal representatives and success would have been held by ASSIGNOR in respective of the entire right, title are gal representatives and success would have been held by ASSIGNOR in respective of the entire right, title are gal representatives and success would have been held by ASSIGNOR in respective of the entire right, title are gal representatives and success would have been held by ASSIGNOR in the firm of wPAT, PC (6)	DNGYE 5TH RD., HSINCHU INDUSTRIA ous of acquiring the entire right, title and interest aluable consideration, receipt of which is here said ASSIGNEE, the entire right, title, and interest cluding any and all Letters Patent granted on an or terms for which the same may be granted, in- assignments, sale, agreement or encumbrance cute any documents that legally may be required er patent application(s) in the United States for ASSIGNEE in and to said INVENTION, all without NEE'S expense, to identify and communicate to are within ASSIGNOR'S possession or control, an equired of ASSIGNOR in respect of the prosecu- ithin the terms of this instrument. ASSIGNOR'S and other legal representatives.

PATENT REEL: 025123 FRAME: 039 \$\frac{1}{5}\$1635

Assignor Name	Address
LIN, SHEN BO	NO. 13, GONGYE 5TH RD., HSINCHU INDUSTRIAL PARK, HUKOU TOWNSHIP, HSINCHU COUNTY 303, TAIWAN, R. O. C.
Signature of Assignor	Date of Signature
ITM SHEN BO	08/09/2010
Name of Witness (optional)	Name of Witness (optional)
Signature of Witness (optional)	Signature of Witness (Optional)

Address
NO. 13, GONGYE 5TH RD., HSINCHU INDUSTRIAL PARK, HUKOU TOWNSHIP, HSINCHU COUNTY 303, TAIWAN, R. O. C.
Date of Signature
08/09/2010
Name of Witness (optional)
Signature of Witness (Optional)

Assignor Name	Address
TSENG WEN LIANG	NO. 13, GONGYE 5TH RD., HSINCHU INDUSTRIAL PARK, HUKOU TOWNSHIP, HSINCHU COUNTY 303, TAIWAN, R. O. C.
Signature of Assignor TSENG Wen Liang	Date of Signature 08/09/2010
Name of Witness (optional)	Name of Witness (optional)
Signature of Witness (optional)	Signature of Witness (Optional)

PATENT REEL: 025123 FRAME: 0392

RECORDED: 10/12/2010